Vishay Siliconix

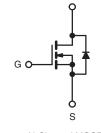


E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.039			
Q _g max. (nC)	362			
Q _{gs} (nC)	48			
Q _{gd} (nC)	98			
Configuration	Single			

TO-247AC





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG73N60E-E3
Lead (Pb)-free and Halogen-free	SiHG73N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T. 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	73	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	46	А
Pulsed Drain Current ^a			I _{DM}	236	
Linear Derating Factor				4.2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	2030	mJ
Maximum Power Dissipation			PD	520	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$			dV/dt	60	
Reverse Diode dV/dt ^d			uv/dl	8.4	V/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 12 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt = 30$ A/µs, starting $T_J = 25 \ ^\circ C.$

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PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	40			00.00		
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.24			- °C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL	1	T CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static							<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μΑ	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		to 25 °C, I _D = 250 μA	-	0.65	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250 μA	2	-	4	V	
			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA	
Zarra Oata Valtarra Dista O sussi				-	-	1		
Zero Gate Voltage Drain Current	IDSS	$\label{eq:VDS} \begin{array}{ c c c } \hline V_{DS} = 600 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 480 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^\circ C \\ \hline V_{GS} = 10 \ V & I_D = 36 \ A \\ \hline \end{array}$		-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}			-	0.032	0.039	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 40 V, I _D = 10 A		-	12	-	S	
Dynamic	•			*	•	•		
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	7700	-		
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	320	-		
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		5	-	pF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	259	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		907	-		
Total Gate Charge	Qg			-	241	362	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 24 \text{ A}, V_{DS} = 480 \text{ V}$	-	48	-		
Gate-Drain Charge	Q _{gd}			-	98	-	1	
Turn-On Delay Time	t _{d(on)}			-	63	95		
Rise Time	tr	Vpp	= 480 V, I _D = 24 A,	-	105	158		
Turn-Off Delay Time	t _{d(off)}	V _{GS}	$= 10 \text{ V}, \text{ R}_{\text{g}} = 10 \Omega$	-	290	435	ns	
Fall Time	t _f			-	120	180]	
Gate Input Resistance	Rg	f = 1	MHz, open drain	-	1.52	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	73		
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction		-	-	200	_ A	
Diode Forward Voltage	V _{SD}	T _J = 25 °0	C, I _S = 36 A, V _{GS} = 0 V	-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}			-	657	1314	ns	
Reverse Recovery Charge	Q _{rr}	T _J = 2	5 °C, I _F = I _S = 24 A,	-	14.6	29.2	μC	
Reverse Recovery Current	I _{RRM}	ai/at =	100 A/µs, V _R = 25 V	-	34.7	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

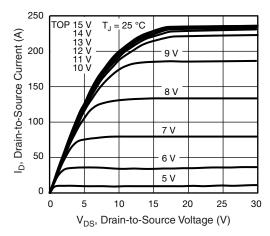


Fig. 1 - Typical Output Characteristics

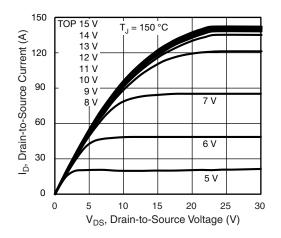


Fig. 2 - Typical Output Characteristics

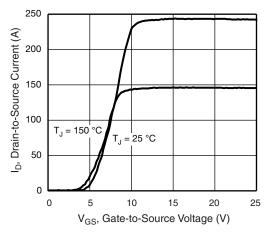


Fig. 3 - Typical Transfer Characteristics

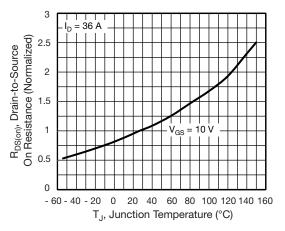


Fig. 4 - Normalized On-Resistance vs. Temperature

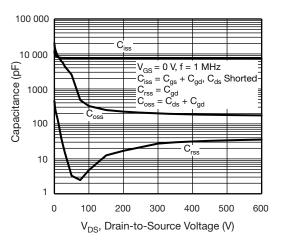


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

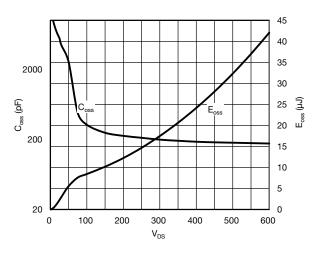


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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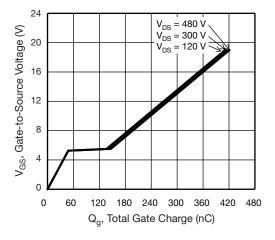


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

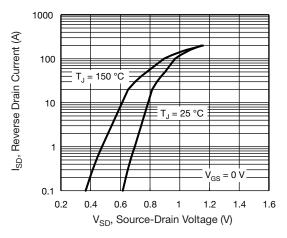


Fig. 8 - Typical Source-Drain Diode Forward Voltage

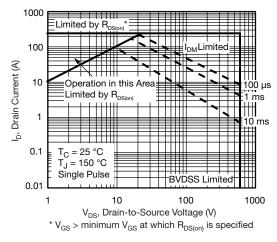


Fig. 9 - Maximum Safe Operating Area

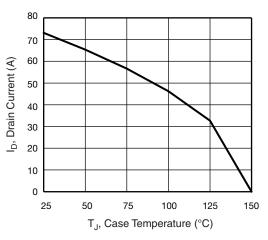


Fig. 10 - Maximum Drain Current vs. Case Temperature

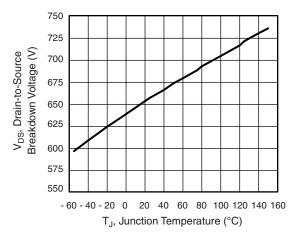


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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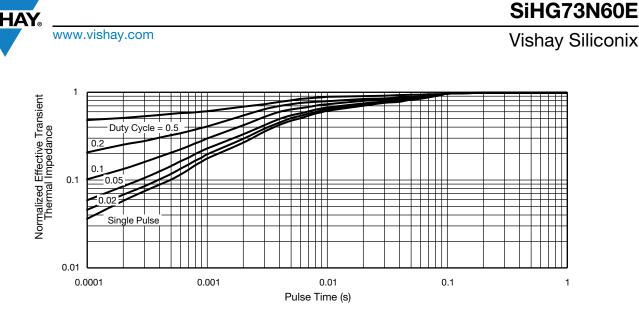


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

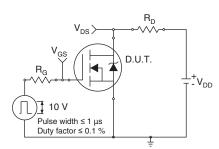


Fig. 13 - Switching Time Test Circuit

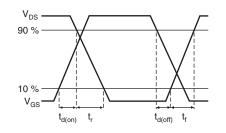


Fig. 14 - Switching Time Waveforms

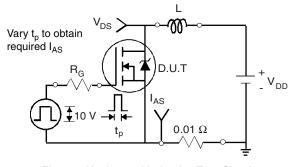


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

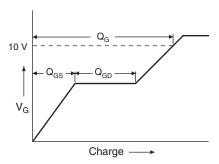


Fig. 17 - Basic Gate Charge Waveform

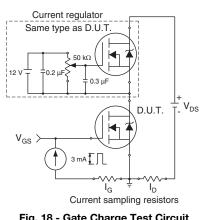


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

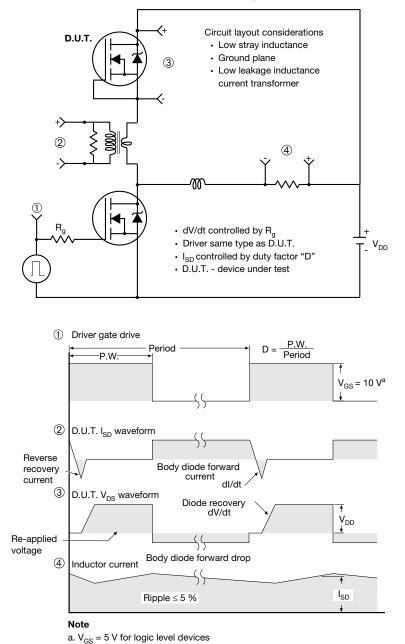


Fig. 19 - For N-Channel

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TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN		
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN		
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44		
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19 ref.		
Q	5.31	5.69	
S	5.54	5.74	

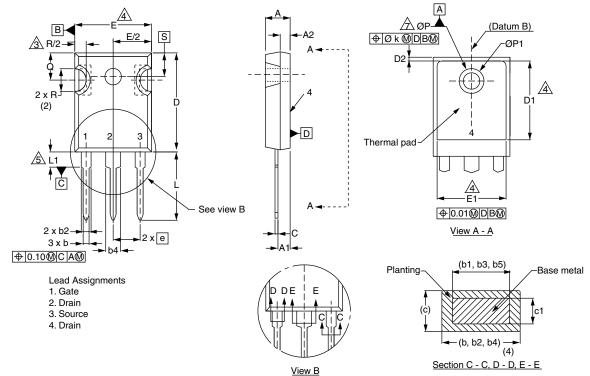
Notes

- ⁽¹⁾ Package reference: JEDEC TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- (4) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



Vishay Siliconix

VERSION 2: FACILITY CODE = Y



MILLIMETERS	ETERS		MILLIN				
DIM.	MIN.	MAX.	NOTES	DIM.	MIN.	MAX.	NOTE
А	4.58	5.31		D2	0.51	1.30	
A1	2.21	2.59		E	15.29	15.87	
A2	1.17	2.49		E1	13.72	-	
b	0.99	1.40		е	5.46	BSC	
b1	0.99	1.35		Øk	0.	254	
b2	1.53	2.39		L	14.20	16.25	
b3	1.65	2.37		L1	3.71	4.29	
b4	2.42	3.43		ØP	3.51	3.66	
b5	2.59	3.38		Ø P1	-	7.39	
С	0.38	0.86		Q	5.31	5.69	
c1	0.38	0.76		R	4.52	5.49	
D	19.71	20.82		S	5.51	BSC	
D1	13.08	-					

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c
- ⁽⁸⁾ Xian and Mingxin actually photo



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